

USB Filter with ESD Protection

NUF2101M

This device is designed for applications requiring **Line Termination**, **EMI Filtering** and **ESD Protection**. It is intended for use in downstream USB 1.1 ports, Cellular phones, Wireless equipment and computer applications. This device offers an integrated solution in a small package (TSOP-6, Case 318G) reducing PCB space and cost.

Features:

- Provides USB Line Termination, Filtering and ESD Protection
- Single IC Offers Cost Savings by Replacing 4 Resistors, 2 Capacitors, and 5 TVs diodes
- EMI Filtering Prevents Noise from Entering/Leaving the System
- IEC61000-4-2 (Level 4) 8 kV (Contact) 15 kV (Air)
- ESD Ratings: Machine Model = C Human Body Model = 3B
- Pb-Free Package is Available

Benefits:

- TSOP-6 Package Minimizes PCB Space
- Integrated Circuit Increases System Reliability versus Discrete Component Implementation
- TVs Devices Provide ESD Protection That is Better than a Discrete Implementation because the Small IC minimizes Parasitic Inductances

Typical Applications:

- USB Hubs
- Computer Motherboards

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Symbol	Rating	Value	Unit
P_{D}	Steady State Power	225	mW
T _{J(max)}	Maximum Junction Temperature	125	°C
T_J	Operating Temperature Range	-55 to +125	°C
T _{stg}	Storage Temperature Range	-55 to +125	°C
TL	Lead Solder Temperature (10 second duration)	260	°C

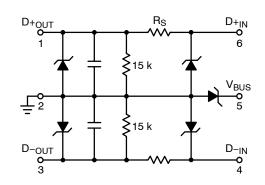
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1



TSOP-6 CASE 318G STYLE 10

SCHEMATIC



MARKING DIAGRAM



SV = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NUF2101MT1G	TSOP-6 (Pb-Free)	3,000/Tape & Reel

DISCONTINUED (Note 1)

NUF2101MT1	TSOP-6	3,000/Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on www.onsemi.com.

NUF2101M

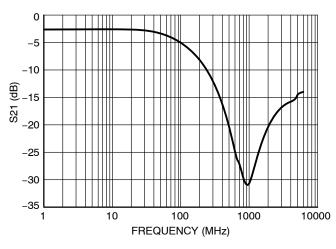
ELECTRICAL CHARACTERISTICS $(T_A = 25^{\circ}C)$

			1 r	Max I _R @ V _{RWM} = 5.25 V V _{BUS} to		I @ VRWM I IVDICALLINE I		Series Resistor R _S (Ω) (Note 1)		Typical Line Pa (O) (Note 1)		ı	Pulldow Resisto R _{pd} (kΩ	r
Device	Device Marking	V _{RWM} (Volts)	Min	Max	GND (μA)	V _{BUS} Pin (μA)	(pF) (Notes 2, 3)	Min	Nom	Max	Min	Nom	Max	
NUF2101MT1	6V	5.25	6.0	8.0	1.0	0.1	55	26.3	30	33.7	13	15	17	
NUF2101MT1G	6V	5.25	6.0	8.0	1.0	0.1	55	26.3	30	33.7	13	15	17	

- 1. For other R_S values (i.e. $R_S = 30~\Omega$) contact your local **onsemi** sales representative. 2. Measured at 25°C, $V_R = 0~V$, f = 1~MHz, Pins 2, 3, 4 or 5 to GND with Pin 1 also grounded. 3. For other capacitance values contact your local **onsemi** sales representative.

NUF2101M

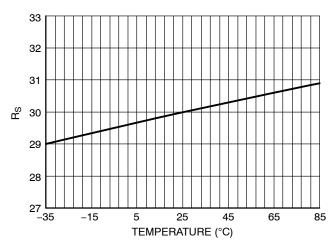
TYPICAL CHARACTERISTICS



0 -10 -20 5 -30 -40 -50 -60 10 100 1000 10000 FREQUENCY (MHz)

Figure 1. Insertion Loss Characteristics

Figure 2. Analog Cross-Talk



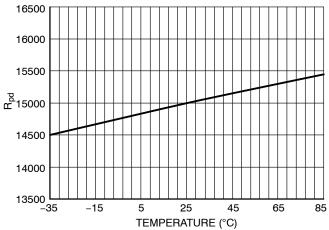


Figure 3. $R_{\rm S}$ vs. Temperature

Figure 4. R_{pd} vs. Temperature

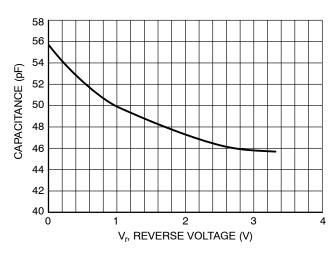


Figure 5. Typical Capacitance





NOTE 5

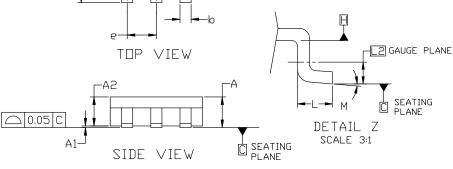
TSOP-6 3.00x1.50x0.90, 0.95P **CASE 318G ISSUE W**

DATE 26 FEB 2024

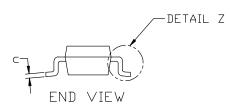


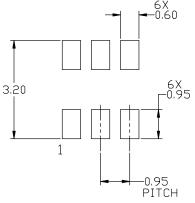
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSIONS D AND E1 ARE DETERMINED AT DATUM H.

 5. PIN 1 INDICATOR MUST BE LOCATED IN THE INDICATED ZONE



N	1ILLIM	IETERS	2
DIM	MIN	NDM	MAX
Α	0.90	1.00	1.10
A1	0.01	0.06	0.10
A2	0.80	0.90	1.00
b	0.25	0.38	0.50
C	0.10	0.18	0.26
D	2.90	3.00	3,10
Е	2.50	2.75	3.00
E1	1.30	1.50	1.70
е	0.85	0.95	1.05
L	0.20	0.40	0.60
L2	(0.25 BSC	
М	0°		10°





RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual, SDLDERRM/D.

DOCUMENT NUMBER:	98ASB14888C	n the Document Repository. O COPY" in red.	
DESCRIPTION:	TSOP-6 3.00x1.50x0.90, 0.	95P	PAGE 1 OF 2

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TSOP-6 3.00x1.50x0.90, 0.95P CASE 318G

ISSUE W

DATE 26 FEB 2024

GENERIC MARKING DIAGRAM*



XXX M=

O =

1 U U

STANDARD

XXX = Specific Device Code

XXX = Specific Device Code

A =Assembly Location

M = Date Code

Y = Year

■ = Pb-Free Package

W = Work Week

vveek

■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 2: PIN 1. EMITTER 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. BASE 2 6. COLLECTOR 2	STYLE 3: PIN 1. ENABLE 2. N/C 3. R BOOST 4. Vz 5. V in 6. V out	STYLE 4: PIN 1. N/C 2. V in 3. NOT USED 4. GROUND 5. ENABLE 6. LOAD	STYLE 5: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR
STYLE 7: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. N/C 5. COLLECTOR 6. EMITTER	STYLE 8: PIN 1. Vbus 2. D(in) 3. D(in)+ 4. D(out)+ 5. D(out) 6. GND	STYLE 9: PIN 1. LOW VOLTAGE GATE 2. DRAIN 3. SOURCE 4. DRAIN 5. DRAIN 6. HIGH VOLTAGE GATE	2. GND ' 3. D(OUT)- 4. D(IN)- 5. VBUS	STYLE 11: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1/GATE 2	STYLE 12: PIN 1. I/O 2. GROUND 3. I/O 4. I/O 5. VCC 6. I/O
STYLE 13: PIN 1. GATE 1 2. SOURCE 2 3. GATE 2 4. DRAIN 2 5. SOURCE 1 6. DRAIN 1	STYLE 14: PIN 1. ANODE 2. SOURCE 3. GATE 4. CATHODE/DRAIN 5. CATHODE/DRAIN 6. CATHODE/DRAIN	PIN 1. ANODE PI 2. SOURCE 3. GATE 4. DRAIN	LE 16: N 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE 6. CATHODE	STYLE 17: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODE 4. ANODE 5. CATHODE 6. COLLECTOR	

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